Supertex inc.

**IRF520 IRF521
IRF522 IRF523
R520 R521**

Preliminary
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N-Channel Enhancement-Mode Vertical DMOS Power FETs

Ordering Information

BV$_{DSS}$ / BV$_{DGS}$	R$_{DS(ON)}$ (max)	I$_{D(ON)}$ (min)	Order Number / Package	
			TO-220	TO-92
100V	0.3Ω	8.0A	IRF520	R520
60V	0.3Ω	8.0A	IRF521	R521
100V	0.4Ω	7.0A	IRF522	—
60V	0.4Ω	7.0A	IRF523	—

Features

☐ Freedom from secondary breakdown

☐ Low power drive requirement

☐ Ease of paralleling

☐ Low C$_{ISS}$ and fast switching speeds

☐ Excellent thermal stability

☐ Integral Source-Drain diode

☐ High input impedance and high gain

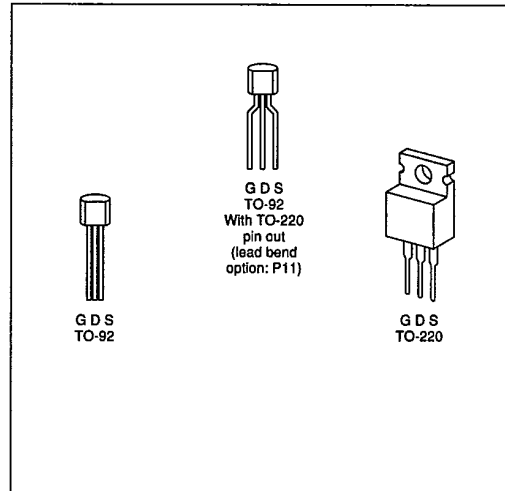☐ Complementary N- and P-Channel devices

Applications

☐ Motor control

☐ Converters

☐ Amplifiers

☐ Switches

☐ Power supply circuits

☐ Drivers (Relays, Hammers, Solenoids, Lamps, Memories, Displays, Bipolar Transistors, etc.)

Absolute Maximum Ratings

Drain-to-Source Voltage	BV$_{DSS}$
Drain-to-Gate Voltage	BV$_{DGS}$
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

*Distance of 1.6 mm from case for 10 seconds.

Advanced DMOS Technology

These enhancement-mode (normally-off) power transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and negative temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex Vertical DMOS Power FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Options

G D S
TO-92
With TO-220
pin out
(lead bend
option: P11)

G D S
TO-92

G D S
TO-220

Thermal Characteristics

Package	I_D (continuous)*	I_D (pulsed)*	Power Dissipation @ T_C = 25°C	θ_{jc} °C/W	θ_{ja} °C/W	I_{DR}	I_{DRM}*
IRF520, IRF521	8.0A	32.0A	40W	80	3.12	8.0A	32.0A
IRF522, IRF523	7.0A	32.0A	40W	80	3.12	8.0A	32.0A
R520, R521	1.0A	9.0A	1W	170	125	1.0A	9.0A

*I_D (continuous) is limited by max rated T_j.

Electrical Characteristics (@ 25°C unless otherwise specified)

T-39-11

(Notes 1 and 2)

Symbol	Parameter		Min	Typ	Max	Unit	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	IRF520, IRF522, R520	100			V	V_{GS} = 0, I_D = 250µA
		IRF521, IRF523, R521	60				
$V_{GS(th)}$	Gate Threshold Voltage		2.0		4.0	V	$V_{GS} = V_{DS}$, I_D = 250µA
I_{GSS}	Gate Body Leakage				500	nA	$V_{GS} = \pm 20V$, V_{DS} = 0
I_{DSS}	Zero Gate Voltage Drain Current				250	µA	V_{GS} = 0, V_{DS} = Max Rating
					1000		V_{GS} = 0, V_{DS} = 0.8 Max Rating T_C = 125°C
$I_{D(ON)}$	ON-State Drain Current	IRF520, IRF521, R520, R521	8.0			A	V_{GS} = 10V $V_{DS} > I_{D(ON)} \times R_{DS(ON)}$ Max Rating
		IRF522, IRF523	7.0				
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance	IRF520, IRF521 R520, R521			0.3	Ω	V_{GS} = 10V, I_D = 4.0A
		IRF522, IRF523			0.4		
G_{FS}	Forward Transconductance		1.5	2.9		℧	$V_{DS} > I_{D(ON)} \times R_{DS(ON)}$ Max Rating I_D = 4.0A
C_{ISS}	Input Capacitance				600		V_{GS} = 0, V_{DS} = 25V f = 1 MHz
C_{OSS}	Common Source Output Capacitance				400	pF	
C_{RSS}	Reverse Transfer Capacitance				100		
$t_{d(ON)}$	Turn-ON Delay Time				40		$V_{DD} = 0.5BV_{DSS}$ I_D = 4.0A V_{DS} = 0.8 Max Rating
t_r	Rise Time				70	ns	
$t_{d(OFF)}$	Turn-OFF Delay Time				100		
t_f	Fall Time				70		
V_{SD}	Diode Forward Voltage Drop	IRF520, IRF521 R520, R521			2.5	V	V_{GS} = 0V, I_{SD} = 1A
		IRF522, IRF523			2.3		V_{GS} = 0V, I_{SD} = 8A
t_{rr}	Reverse Recovery Time			280		ns	T_j = 150°C, I_F = 8.0A, $dI_{F/dt}$ = 100A/µS

Note 1: All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
Note 2: All A.C. parameters sample tested.

Switching Waveforms and Test Circuit